### => FILE REG

FILE 'REGISTRY' ENTERED AT 17:34:49 ON 17 AUG 2007

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### => DISPLAY HISTORY FULL L1-

### FILE 'REGISTRY' ENTERED AT 17:00:58 ON 17 AUG 2007

E NICKEL/CN

- L1 1 SEA NICKEL/CN
  - E COPPER/CN
- L2 1 SEA COPPER/CN
  - E LITHIUM/CN
- L3 1 SEA LITHIUM/CN

### FILE 'HCA' ENTERED AT 17:06:06 ON 17 AUG 2007

- L4 241490 SEA (BATTERY OR BATTERIES OR (ELECTROCHEM? OR ELECTROLY? OR GALVANI? OR WET OR DRY OR PRIMARY OR SECONDARY)(2A)(CE LL OR CELLS) OR WETCELL? OR DRYCELL?)/BI,AB
- L5 246455 SEA ANOD## OR (NEG# OR NEGATIV?)(2A)ELECTROD##
- L6 10135 SEA (L3 OR LITHIUM# OR LITHIAT? OR LI)(2A)(FILM? OR COAT? OR LAYER?)
- L7 344311 SEA L1
- L8 541678 SEA L2
- L9 2740 SEA MEAN#(2A)(ROUGH? OR COARS?)
- L10 5758 SEA (COND# OR CONDUCT?)(2A)(AGENT? OR ADDITIV?)
- L11 54653 SEA METAL####(2A)(POLYM# OR POLYMER? OR COPOLYM# OR COPOLYMER? OR HOMOPOLYM# OR HOMOPOLYMER? OR RESIN?)
- L12 53052 SEA (COND# OR CONDUCT?)(2A)(POLYM# OR POLYMER? OR COPOLYM# OR COPOLYMER? OR HOMOPOLYM# OR HOMOPOLYMER? OR RESIN?)
- L13 2095 SEA L4 AND L5 AND L6
- L14 1 SEA L13 AND L9
- L15 2312 SEA L5 AND L6
- L16 1 SEA L15 AND L9
- L17 64548 SEA L4 AND L5
- L18 6 SEA L17 AND L9 L19 43 SEA L5 AND L9
- L20 13 SEA L4 AND L9
- L21 1 SEA (L19 OR L20) AND L6
- L22 11 SEA L6 AND L9
- L23 QUE L3 OR LITHIUM# OR LITHIAT? OR LI
- L24 6 SEA L19 AND L23
- L25 2 SEA L19 AND (L10 OR L11 OR L12)
- L26 1 SEA L19 AND L7
- L27 12 SEA L19 AND L8

SEL L14 1 RN

### FILE 'REGISTRY' ENTERED AT 17:26:42 ON 17 AUG 2007

L28 32 SEA (7704-34-9/BI OR 114239-80-4/BI OR 1332-29-2/BI OR

## FILE 'HCA' ENTERED AT 17:26:50 ON 17 AUG 2007

- L29 1843654 SEA L28
- L30 15 SEA L19 AND L29
- L31 6 SEA L14 OR L16 OR L18 OR L21 OR L24 OR L25 OR L26
- L32 28 SEA (L20 OR L22 OR L27 OR L30) NOT L31
- L33 3 SEA 1840-2002/PY,PRY AND L31
- L34 14 SEA 1840-2002/PY,PRY AND L32
- L35 17 SEA (L31 OR L32) NOT (L33 OR L34)

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FILE 'HCA' ENTERED AT 17:35:04 ON 17 AUG 2007
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=> D L33 1-3 BIB ABS HITSTR HITIND
L33 ANSWER 1 OF 3 HCA COPYRIGHT 2007 ACS on STN
AN 140:342224 HCA Full-text
TI Anode for lithium secondary battery
IN Lee, Jea-Woan; Cho, Chung-Kun
PA Samsung SDI Co., Ltd., S. Korea
SO U.S. Pat. Appl. Publ., 10 pp.
  CODEN: USXXCO
DT Patent
LA English
FAN.CNT 1
  PATENT NO.
                    KIND DATE
                                    APPLICATION NO.
                                                          DATE
PI US 2004081889
                     A1 20040429 US 2003-603777
                                   200306
  KR 2004036438
                         20040430 KR 2002-65483
                                   200210
                                   25
  JP 2004146348
                        20040520
                                  JP 2003-164281
                                   200306
                                   09
                          <--
  EP 1416573
                  A2 20040506 EP 2003-90199
                                   200307
                                   04
                          <--
                  A3 20040804
  EP 1416573
     R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC,
      PT, IE, SI, LT, LV, FI, RO, MK, CY, AL, TR, BG, CZ, EE, HU,
      SK
  CN 1492529
                       20040428 CN 2003-145389
                                   200307
                                   07
  KR 2005039774
                         20050429
                                   KR 2005-16541
                                   200502
                                   28
                          20021025 <---
PRAI KR 2002-65483
         A neg. electrode for a lithium secondary battery includes a substrate having a mean roughness of 30 to 4000 Å and a lithium layer
AB
         coated on the substrate, and a lithium secondary battery includes the neg. electrode. The obtained lithium secondary battery has
         improved cycle-life characteristics.
IT 7439-93-2, Lithium, uses
    (anode for lithium secondary battery
RN 7439-93-2 HCA
```

=> FILE HCA

CN Lithium (CA INDEX NAME)

IT 7440-02-0, Nickel, uses

```
(substrate; anode for lithium secondary
     battery)
RN 7440-02-0 HCA
CN Nickel (CA INDEX NAME)
 Νi
IC ICM H01M004-64
   ICS H01M004-60; H01M004-58; H01M004-48
INCL 429233000; 429245000; 429231950; 429231100; 429218100; 429213000
CC 52-2 (Electrochemical, Radiational, and Thermal Energy Technology)
   Section cross-reference(s): 38
ST anode lithium secondary battery
IT Battery anodes
   Perovskite-type crystals
     (anode for lithium secondary battery
IT Carbon black, uses
   Carbonaceous materials (technological products)
   Fluoropolymers, uses
    (anode for lithium secondary battery
IT Polyamides, uses
    (anode for lithium secondary battery
IT Polycarbonates, uses
    (anode for lithium secondary battery
IT Polyesters, uses
    (anode for lithium secondary battery
IT Polyolefins
    (anode for lithium secondary battery
IT Chalcogenides
   Oxides (inorganic), uses
    (lithiated; anode for lithium
    secondary battery)
IT Secondary batteries
    (lithium; anode for lithium
    secondary battery)
IT Conducting polymers
    (substrate; anode for lithium secondary
    battery)
IT Metals, uses
   Polyacenes
   Polyacetylenes, uses
    (substrate; anode for lithium secondary
    battery)
IT 7704-34-9, Sulfur, uses 7704-34-9D, Sulfur, compd. 9002-88-4,
```

Polyethylene 9003-07-0, Polypropylene 9010-79-1,

```
Ethylene-propylene copolymer 63143-57-7D, Carbon sulfide, polymer
   74432-42-1, Lithium polysulfide
     (anode for lithium secondary battery
IT 1332-29-2, Tin oxide 7439-93-2, Lithium, uses
   7440-31-5, Tin, uses 7782-42-5, Graphite, uses 9002-84-0, Ptfe
   9002-86-2, Polyvinyl chloride 9003-53-6, Polystyrene 9011-14-7,
   Pmma 13463-67-7, Titanium oxide, uses 14417-93-7, Tin phosphate
   24937-79-9, Pvdf 25014-41-9, Polyacrylonitrile
     (anode for lithium secondary battery
IT 24968-12-5, Polybutylene terephthalate 25038-59-9, Polyethylene
   terephthalate, uses 413569-08-1, 2-Propenoic acid, ion(1-)
   homopolymer, uses
     (anode for lithium secondary battery
IT 7440-02-0, Nickel, uses 7440-50-8, Copper, uses
   25067-58-7, Polyacetylene 25190-62-9, Poly(p-phenylene)
   25233-30-1, Polyaniline 25233-34-5, Polythiophene 28774-98-3,
   Polynaphthalene-2,6-diyl 30604-81-0, Polypyrrole 82451-56-7,
   Polyazulene 96638-49-2, Poly(phenylene vinylene) 114239-80-4,
   Polyperinaphthalene
     (substrate; anode for lithium secondary
     battery)
L33 ANSWER 2 OF 3 HCA COPYRIGHT 2007 ACS on STN
AN 139:103765 HCA Full-text
TI Secondary lithium battery anodes
   inhibiting deformation in repeated charging and discharging, and
   same batteries
IN Kusumoto, Yasuyuki; Fukui, Atsushi; Nakamura, Hiroshi
PA Sanyo Electric Co., Ltd., Japan
SO Jpn. Kokai Tokkyo Koho, 12 pp.
   CODEN: JKXXAF
DT Patent
LA Japanese
FAN.CNT 1
   PATENT NO.
                      KIND DATE
                                        APPLICATION NO.
                                                                 DATE
PI JP 2003203637
                           20030718 JP 2001-401286
                                       200112
                                       28
   US 2003148185
                           20030807 US 2002-329571
                                       200212
                                       27
                             <--
   US 6946223
                     B2 20050920
PRAI JP 2001-401286
                             20011228 <---
          The anodes comprise anode active mass capable of alloying with Li, and current collectors with proportional limit ≥2.0 N/mm.
AB
          Alternatively, the anodes are prepd. by applying active mass contg. Si-contg. substances, elec. conductive carbon materials, and binders
          on the surface of current collectors, and sintering in nonoxidizing atm.; wherein the arithmetic mean roughness (Ra) of the current
          collector surface is \ge 0.2 \, \mu m, the thickness (X \mu m) of the active mass layer satisfies [250 \ge (X/Ra)], and the contents of the carbon
          materials and binders in the active mass are of 0.5-30 wt.% and 5-40 wt.%, resp. The anode active mass layer show high and durable
          adhesion with the current collectors and inhibits deformation in the repeated charging-discharging cycling.
IC ICM H01M004-66
   ICS H01M004-02; H01M004-38; H01M004-62; H01M010-40
CC 52-2 (Electrochemical, Radiational, and Thermal Energy Technology)
ST lithium battery anode current
   collector surface roughness; stress strain relationship
   lithium battery anode current collector:
   silicon anode lithium battery current
```

collector; copper current collector lithium battery anode; sintering lithium battery anode active mass IT Fluoropolymers, uses (binder in anodes; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT Polyimides, uses (binder in anodes; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT Carbon black, uses (elec. conductive agents in anodes; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT Secondary batteries (lithium; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT Sintering (of anode active mass; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT Stress-strain relationship Surface roughness (of current collectors in anodes; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT Battery anodes (secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT Copper alloy, base (current collectors in anodes; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT 7440-21-3, Silicon, uses (anode active mass; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT 24937-79-9, Polyvinylidene fluoride (binder in anodes; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) IT 7440-50-8, Copper, uses (current collectors in anodes; secondary Li battery anodes contg. current collectors with prescribed surface roughness or stress-strain relationships) L33 ANSWER 3 OF 3 HCA COPYRIGHT 2007 ACS on STN

AN 134:355474 HCA Full-text

TI Battery electrodes including particles of specific sizes

IN Buckley, James P.; Ghantous, Dania I.; Hoang, Khanh; Horne, Craig R.; Bi, Xiangxin

PA Nanogram Corporation, USA

SO PCT Int. Appl., 78 pp.

CODEN: PIXXD2

DT Patent

LA English

FAN.CNT 30

PATENT NO.

KIND DATE APPLICATION NO.

DATE

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PI WO 2001035473
                        Αl
                             20010517 WO 2000-US30543
                                      200011
                                      06
     W: CN, IN, JP, KR
     RW: AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC,
       NL, PT, SE, TR
   EP 1249047
                         20021016 EP 2000-979141
                    A1
                                      200011
                                      06
     R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC,
       PT, IE, FI, CY, TR
   JP 2003514353
                     T
                         20030415 JP 2001-537112
                                      200011
                                      06
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   TW 488100
                         20020521 TW 2000-89123615
                                      200011
                                      08
                            <--
   CN 1531480
                         20040922 CN 2001-820305
                                      200110
                                      26
   IN 2002CN00738
                           20070223
                                      IN 2002-CN738
                       Α
                                      200205
                                      20
PRAI US 1999-435748
                         Α
                             19991108 <--
                           20001026 <--
  US 2000-243491P
                       P
                        W
   WO 2000-US30543
                             20001106 <--
AB
          Embodiments of electrodes include a collection of particles having an av. diam. less than about 100 nm and have a root mean square
          surface roughness less than about one micron. Electrodes can be formed with a collection of electroactive nanoparticles having a narrow
          particle size distribution. Electrodes can be formed having an av. thickness less than about 10 µm that include particles having an av.
          diam. less than about 100 nm. Thin electrodes can be used in the formation of thin batteries in which at least one of the electrodes
          includes nanoscale electroactive particles.
IT 7439-93-2, Lithium, uses
    (battery electrodes including particles of specific
    sizes)
RN 7439-93-2 HCA
CN Lithium (CA INDEX NAME)
```

specific sizes) RN 7439-93-2 HCA

CN Lithium (CA INDEX NAME)

Li

IT 7439-93-2D, Lithium, intercalation compd., uses (particles; battery electrodes including particles of IC ICM H01M004-36

CC 52-2 (Electrochemical, Radiational, and Thermal Energy Technology)

ST battery electrode nanoparticle

IT Battery anodes

Battery cathodes

Nanoparticles

Particle size distribution

Surface roughness

(battery electrodes including particles of specific

sizes)

IT Carbon fibers, uses

(battery electrodes including particles of specific sizes)

IT Metals, uses

(particles; battery electrodes including particles of specific sizes)

IT Thermal decomposition

(photo-; battery electrodes including particles of specific sizes)

IT Lithium alloy, base

(battery electrodes including particles of specific sizes)

IT 1332-29-2, Tin oxide 11099-11-9, Vanadium oxide 11105-02-5,

Silver vanadium oxide 11126-12-8, Iron sulfide 11126-15-1,

Lithium vanadium oxide 11129-60-5, Manganese oxide

12612-50-9, Molybdenum sulfide 13463-67-7, Titanium oxide, uses

39300-70-4, Lithium nickel oxide 39302-37-9,

Lithium titanium oxide 39457-42-6, Lithium

Manganese oxide 52627-24-4, Cobalt lithium oxide

80341-49-7, Iron lithium sulfide 121339-43-3,

Lithium Silver vanadium oxide 160479-36-7, Lithium

tin oxide

(battery electrodes including particles of specific

sizes)

IT 7440-44-0, Carbon, uses 7782-42-5, Graphite, uses

(battery electrodes including particles of specific sizes)

IT 7439-93-2, Lithium, uses

(battery electrodes including particles of specific

IT 7429-90-5, Aluminum, uses 7440-50-8, Copper, uses 12597-68-1,

Stainless steel, uses

(current collector; battery electrodes including

particles of specific sizes)

IT 7439-93-2D, Lithium, intercalation compd., uses

(particles; battery electrodes including particles of specific sizes)

RE.CNT 5 THERE ARE 5 CITED REFERENCES AVAILABLE FOR THIS RECORD

ALL CITATIONS AVAILABLE IN THE RE FORMAT

### => D L34 1-14 BIB ABS HITSTR HITIND

L34 ANSWER 1 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 137:224969 HCA Full-text

TI Fabrication and properties of epitaxial lithium niobate

thin films by Combustion Chemical Vapor Deposition (CCVD)

AU Jiang, Yong Dong; McGee, Jake; Polley, Todd A.; Schwerzel, Robert E.; Hunt, Andrew T.

CS MicroCoating Technologies, Atlanta, GA, 30341, USA

SO Materials Research Society Symposium Proceedings (2002), 688(Ferroelectric Thin Films X), 297-302

CODEN: MRSPDH; ISSN: 0272-9172

PB Materials Research Society

DT Journal

LA English

AB Lithium niobate has a wide variety of applications because of its excellent ferroelec., piezoelec. and electrooptic properties. In this study, epitaxial lithium niobate thin films were deposited on c-sapphire (α-Al2O3) by the low-cost, open-atm. Combustion Chem. Vapor Deposition (CCVD) technique developed by MicroCoating Technologies, Inc. It was found that deposition temp. plays a crit. role in detg. the growth behavior and quality of the lithium niobate thin films. XRD measurements show that the lithium niobate films are epitaxial with two in-plane orientations (twin structure). A surface roughness (root mean square) of about 4 nm was obtained from the deposited film (about 200 nm thick), as measured by optical profilometry.

CC 76-7 (Electric Phenomena)

ST epitaxial lithium niobate film combustion CVD

IT Vapor deposition process

(chem., combustion; fabrication and properties of epitaxial lithium niobate thin films by Combustion chem.

Vapor Deposition (CCVD))

IT Crystal growth

Crystal structure

Surface roughness

(fabrication and properties of epitaxial lithium niobate thin films by Combustion chem. Vapor Deposition (CCVD))

IT 1344-28-1, Alumina, uses

(fabrication and properties of epitaxial lithium niobate thin films by Combustion chem. Vapor Deposition (CCVD))

IT 12031-63-9P, Lithium niobate

(fabrication and properties of epitaxial lithium niobate thin films by Combustion chem. Vapor Deposition (CCVD))

IT 1317-82-4, Sapphire

(substrate; fabrication and properties of epitaxial lithium niobate thin films by Combustion chem.

Vapor Deposition (CCVD))

RE.CNT 19 THERE ARE 19 CITED REFERENCES AVAILABLE FOR THIS RECORD ALL CITATIONS AVAILABLE IN THE RE FORMAT

L34 ANSWER 2 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 134:214074 HCA Full-text

TI Diamond Optically Transparent Electrodes: Demonstration of Concept with Ferri/Ferrocyanide and Methyl Viologen

AU Zak, Jerzy K.; Butler, James E.; Swain, Greg M.

CS Faculty of Chemistry, Silesian Technical University, Gliwice, 44-100, Pol.

SO Analytical Chemistry (2001), 73(5), 908-914

CODEN: ANCHAM; ISSN: 0003-2700

PB American Chemical Society

DT Journal

LA English

AB

A new type of optically transparent electrode is reported on - an elec. conductive diamond thin film. The electrode was free-standing (0.38 mm thick and 8 mm in diam.), mech. polished to a 7-nm root- mean-square roughness over a 10-μm linear distance, boron-doped (0.05% B/C in the reactant gas mixt.), and mounted in a thin-layer transmission cell. The electrode has a short-wavelength cutoff of .apprx.225 nm, which is the indirect band gap of the material, and transmits light out to at least 1000 nm. In theory, the electrode has an optical window from 225 nm well out into the far-IR, except for the boron acceptor band and the intrinsic multiphonon absorptions. The electrode was used to electrooxidize ferrocyanide to ferricyanide, and the absorbance change assocd. with the formation of the oxidized product (λmax = 420 nm) was spectroscopically monitored. The electrode was also used to electroreduce Me viologen (MV2+) to the cation radical (MV+•) and the neutral (MV0). The depletion of MV2+ (λmax = 257 nm) and formation of MV+• (λmax = 398 and 605 nm) were spectroscopically monitored.

CC 72-2 (Electrochemistry)

Section cross-reference(s): 22, 67, 73, 75, 76

IT Electrolytic cells

(spectrochem.; with optically transparent elec. conductive

boron-doped diamond)

# RE.CNT 49 THERE ARE 49 CITED REFERENCES AVAILABLE FOR THIS RECORD ALL CITATIONS AVAILABLE IN THE RE FORMAT

L34 ANSWER 3 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 132:229664 HCA Full-text

TI Growth of LiNbO3 epitaxial films by oxygen radical-assisted laser molecular beam epitaxy

AU Matsubara, K.; Niki, S.; Watanabe, M.; Fons, P.; Iwata, K.; Yamada, A.

CS Electrotechnical Laboratory, Tsukuba, 305-8568, Japan

SO Applied Physics A: Materials Science & Processing (1999), 69(Suppl.), S679-S681

CODEN: APAMFC; ISSN: 0947-8396

PB Springer-Verlag

DT Journal

LA English

AB LiNbO3 films were epitaxially grown on c-sapphire substrates using O radical-assisted laser MBE. X-ray diffraction-based structural anal. showed that the films were epitaxial. Triple-axis rocking curve measurements of the LiNbO3 (0006) reflection revealed that the film was highly c-oriented with an extremely narrow mosaic; the full width at half max. of the LiNbO3 (0006) rocking curve was 0.0036°, comparable to the value of high-quality bulk crystals. The surface of the film was very smooth, with a surface roughness root-mean-square value, measured by at. force microscope, of 0.4 nm for a film of thickness 15 nm. The chem. compn. of the film measured by XPS was stoichiometric within the accuracy of XPS measurement.

CC 75-1 (Crystallography and Liquid Crystals)

ST lithium niobate film oxygen radical assisted

laser MBE

IT Composition

Surface roughness

(of lithium niobate epitaxial films grown by

oxygen radical-assisted laser MBE)

RE.CNT 13 THERE ARE 13 CITED REFERENCES AVAILABLE FOR THIS RECORD ALL CITATIONS AVAILABLE IN THE RE FORMAT

# L34 ANSWER 4 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 131:79879 HCA Full-text

TI SnO2(Sb) electrodes: morphological changes due to polarizations in the HER and OER potential regions studied by in situ STM and ex situ AFM imaging

AU Longo, C.; Abadal, G.; Sanz, F.; Sumodjo, P. T. A.

CS Instituto de Quimica, Universidade de Sao Paulo, Sao Paulo, 05599-970, Brazil

SO Journal of the Electrochemical Society (1999), 146(6),

2169-2174

CODEN: JESOAN; ISSN: 0013-4651

PB Electrochemical Society

DT Journal

LA English AB TI

The effect of electrochem. perturbation on the microstructure of transparent Sb-doped SnO2 electrode in 0.1 M NaClO4, pH 2, was investigated by in situ scanning tunneling microscopy (STM), ex situ at. force microscopy (AFM), SEM, and other techniques of microstructure anal. The transparent film of SnO2(Sb) on silica prepd. by spray pyrolysis has a uniform and smooth surface with a root-mean-square (rms) roughness ranging from 1 to 2 nm. Its microstructure is constituted of coalesced particles with an av. diam. and height of 30 and 6 nm, resp. Anodic polarization at potentials near the oxygen evolution reaction region (OER) or potential cycling induces small alterations on the microstructure of the electrode, observable only in submicron range by AFM anal. Cathodic polarization at potentials in the region of the hydrogen evolution reaction (HER), however, strongly damages the film. AFM and STM examn. revealed that the particle boundaries are attacked and both vertical and lateral dimensions of the particles decrease. From the observations, it can be inferred that during the cathodic polarization SnO is formed, and destruction of the film occurs by dissoln. of that more sol. oxide. In situ STM expts. showed that at the initial stages the particles of the damaged film can acquire dimensions even larger than the initial size by anodic polarization. Finally, it can be concluded that a smooth and compact film with few defects is less susceptible to degrdn.

IT 1332-29-2, Tin oxide

(Sb-doped; SnO2(Sb) electrodes: morphol. changes due to polarizations in HER and OER potential regions studied by in situ

STM and ex situ AFM imaging)

RN 1332-29-2 HCA

CN Tin oxide (CA INDEX NAME)

\*\*\* STRUCTURE DIAGRAM IS NOT AVAILABLE \*\*\*

CC 72-2 (Electrochemistry)

Section cross-reference(s): 66

IT Anodic polarization

Cathodic polarization

(of transparent Sb-doped SnO2 films in NaClO4 soln.)

IT 1332-29-2, Tin oxide

(Sb-doped; SnO2(Sb) electrodes: morphol. changes due to

polarizations in HER and OER potential regions studied by in situ

STM and ex situ AFM imaging)

RE.CNT 52 THERE ARE 52 CITED REFERENCES AVAILABLE FOR THIS RECORD

ALL CITATIONS AVAILABLE IN THE RE FORMAT

## L34 ANSWER 5 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 129:47201 HCA Full-text

TI Structural and optical properties of LiNbO3 films grown by pulsed laser deposition with a shadow mask

AU Kim, Dong-Wook; Oh, Sang-Moon; Lee, See-Hyung; Noh, T. W.

CS Dep. Physics, Condensed Matter Res. Inst., Seoul Natl. Univ., Seoul, 151-742, S. Korea

SO Japanese Journal of Applied Physics, Part 1: Regular Papers, Short

Notes & Review Papers (1998), 37(4A), 2016-2020

CODEN: JAPNDE; ISSN: 0021-4922

PB Japanese Journal of Applied Physics

DT Journal

LA English

AB High-quality LiNbO3 thin films were grown by pulsed laser deposition (PLD) with a shadow mask. Epitaxial and twin-films were obtained using a single crystal target without a post-annealing process. The film had a very smooth surface without the particular problem, which is common in films grown by conventional PLD. The root-mean -square surface roughness was only 3.6 nm, and optical propagation loss was ≥3 dB/cm.

CC 73-11 (Optical, Electron, and Mass Spectroscopy and Other Related

Properties)

Section cross-reference(s): 75

ST structural optical property lithium niobate film

; laser deposition shadow mask niobate

RE.CNT 15 THERE ARE 15 CITED REFERENCES AVAILABLE FOR THIS RECORD

ALL CITATIONS AVAILABLE IN THE RE FORMAT

### L34 ANSWER 6 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 128:328979 HCA Full-text

TI Epitaxial LiNbO3 thin films grown by the "eclipse method"

AU Kim, Dong-Wook; Oh, Sang-Moon; Noh, T. W.; Lee, See-Hyung

CS Department of Physics and Condensed Matter Research Institute, Seoul

National University, Seoul, 151-742, S. Korea

SO Journal of the Korean Physical Society (1998), 32(Suppl.,

Proceedings of the 9th International Meeting on Ferroelectricity,

1997, Pt. 4), S1408-S1410

CODEN: JKPSDV; ISSN: 0374-4884

PB Korean Physical Society

DT Journal

LA English

AB LiNbO3 thin films were grown by pulsed laser deposition (PLD) with a shadow mask, which is called the eclipse method. Epitaxial twinfree films were obtained using a single crystal target without a post-annealing process. The films had very smooth surface without the particulate problem, which is common in films grown by conventional PLD. The root-mean-square surface roughness was only 3 nm, and optical propagation loss was  $\geq 3$  dB/cm.

CC 75-1 (Crystallography and Liquid Crystals)

Section cross-reference(s): 73

IT Surface smoothness

(of lithium niobate epitaxial film grown by

pulsed laser deposition with shadow mask)

IT Optical properties

(propagation loss; of lithium niobate epitaxial

film grown by pulsed laser deposition with shadow mask)

RE.CNT 12 THERE ARE 12 CITED REFERENCES AVAILABLE FOR THIS RECORD ALL CITATIONS AVAILABLE IN THE RE FORMAT

### L34 ANSWER 7 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 128:315252 HCA Full-text

TI Reduced optical losses in MOCVD grown lithium niobate thin films on sapphire by controlling nucleation density

AU Lee, S. Y.; Feigelson, R. S.

CS Department of Materials Science and Engineering, Stanford University, Stanford, CA, 94305, USA

SO Journal of Crystal Growth (1998), 186(4), 594-606

CODEN: JCRGAE; ISSN: 0022-0248

PB Elsevier Science B.V.

DT Journal

LA English

LiNbO3 epitaxial thin films of high cryst. quality were grown on c-plane sapphire substrates by the solid-source MOCVD method. For waveguiding applications, low optical propagation losses (<2 dB/cm) are required, and this was difficult to achieve in films grown by various vapor growth techniques. Since scattering from rough film surfaces is a major source of optical attenuation, a knowledge of the mechanisms involved in film roughening and their relation with the initial stage of film formation is essential. Roughening and optical losses in Li niobate films grown on sapphire substrates increased with grain size and the depth of grain grooves formed between them. Increasing the nucleation d. during the initial stage of growth can inhibit grain growth, and thereby reduce surface roughness even at high growth temps. Based on these results, a two-step growth process was developed in which the nucleation and growth stages were controlled sep. This process involves (1) creating a high nucleation d. by using either a low deposition temp. or high source partial pressure during the early stages of film growth, and (2) enhancing crystallinity by growing the balance of the film at a higher temp. or lower source partial pressure. Using this refined growth process, root-mean -square roughness was decreased to <2 nm, while the cryst. quality remained equal to the best films grown by the conventional one step growth method. Optical losses were reduced to <1.8 dB/cm for the TEo mode at a wavelength of 632.8 nm.

CC 75-1 (Crystallography and Liquid Crystals)

Section cross-reference(s): 66, 73

IT Optical properties

(loss; reduced optical losses and surface roughness of metalorg.

VPE grown lithium niobate thin films on sapphire by controlling nucleation d.)

IT Crystal nucleation

Metalorganic vapor phase epitaxy

Surface roughness

(reduced optical losses and surface roughness of metalorg. VPE

grown lithium niobate thin films on sapphire

by controlling nucleation d.)

IT 12031-63-9, Lithium niobate (LiNbO3)

(reduced optical losses and surface roughness of metalorg. VPE

grown lithium niobate thin films on sapphire

by controlling nucleation d.)

RE.CNT 33 THERE ARE 33 CITED REFERENCES AVAILABLE FOR THIS RECORD ALL CITATIONS AVAILABLE IN THE RE FORMAT

### L34 ANSWER 8 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 127:254443 HCA Full-text

TI Sequential in situ STM imaging of electrodissolving copper single-crystal domains in aqueous perchloric acid: kinetics and mechanism of the interface evolution

AU Aziz, S. G.; Vela, M. E.; Andreasen, G.; Salvarezza, R. C.; Hernandez-Creus, A.; Arvia, A. J.

CS Instituto Investigaciones Fisicoquimicas Teoricas Aplicadas (INIFTA), La Plata, 1900, Argent.

SO Physical Review B: Condensed Matter (1997), 56(7), 4166-4175

CODEN: PRBMDO; ISSN: 0163-1829

PB American Physical Society

DT Journal

LA English

The evolution of Cu crystal surfaces in an aq. perchloric acid soln. at both null (j = 0) and const. anodic apparent c.d.  $(j = 6 \mu A \text{ cm-2})$  at room temp. was followed by in situ scanning tunneling microscopy sequential imaging. For j = 0, the Cu surface turns out to be highly dynamic as terrace growth, step displacement, and smoothening of small pits can be obsd. These processes lead to a small decrease in the value of the root-mean-square roughness  $(\xi)$ . However, for  $j = 6 \mu A$  cm-2, an inhomogeneous attack proceeds with a marked increase in  $\xi$ . In this case, while some surface domains become progressively rough others develop nm-sized etched pits that turn the interface unstable. The evolution of the Cu topog. under the exptl. conditions of this work was simulated using a Monte Carlo algorithm based on a dissoln. model in which surface processes are influenced by inhomogeneity stabilizing cavities.

IT 7440-50-8, Copper, properties

(sequential in situ STM imaging of electrodissolving copper single-crystal domains in aq. perchloric acid: kinetics and mechanism of interface evolution)

RN 7440-50-8 HCA

CN Copper (CA INDEX NAME)

Cu

CC 72-2 (Electrochemistry)

Section cross-reference(s): 56, 66

IT 7440-50-8, Copper, properties

(sequential in situ STM imaging of electrodissolving copper single-crystal domains in aq. perchloric acid: kinetics and mechanism of interface evolution)

RE.CNT 41 THERE ARE 41 CITED REFERENCES AVAILABLE FOR THIS RECORD ALL CITATIONS AVAILABLE IN THE RE FORMAT

# L34 ANSWER 9 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 124:13187 HCA Full-text

TI In-situ stress investigations on thin copper films with the STM

AU Fries, Thomas; Oster, Klaus; Wandelt, Klaus

CS Inst. Phys. Chem., Univ. Bonn, Bonn, D-53155, Germany

SO Advanced Materials (Weinheim, Germany) (1994), 6(6), 473-6

CODEN: ADVMEW; ISSN: 0935-9648

PB VCH

DT Journal

LA English

AB The effects of external mech. stress at the surface of nanocryst. (cryst. size 50-60 nm) 1 µm thin Cu films prepd. by an anodic vacuum arc on Si(100) were studied. Stress was applied by a sample holder for 3 point bending measurements in the scanning tunneling microscope (STM). Forces as low as 0.2 N resulted in local plastic deformations. Recovery and recrystn. were obsd. by the root mean square surface roughness and structural changes, resp. Qual. and quant. characterization of the structural changes was achieved by evaluation of the STM data for topog, and surface roughness. The rate of transport of material was evaluated.

IT 7440-50-8, Copper, properties

(in situ stress investigations including structural surface changes on thin Cu films by STM)

RN 7440-50-8 HCA

CN Copper (CA INDEX NAME)

Cu

CC 56-6 (Nonferrous Metals and Alloys)

IT 7440-50-8, Copper, properties

(in situ stress investigations including structural surface changes on thin Cu films by STM)

L34 ANSWER 10 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 123:182003 HCA Full-text

TI Optical losses in ferroelectric oxide thin films: is there light at the end of the tunnel?

AU Fork, D. K.; Armani-Leplingard, F.; Kingston, J. J.

CS Xerox Palo Alto Res. Cent., Palo Alto, CA, 94304, USA

SO Materials Research Society Symposium Proceedings (1995),

361(Ferroelectric Thin Films IV), 155-66 CODEN: MRSPDH; ISSN: 0272-9172

PB Materials Research Society

DT Journal

LA English

Optical losses are a barrier to use of ferroelec. waveguide thin films. Losses of .apprx.2 dB/cm will reduce the efficiency of a frequency doubler by over 50%. Achieving losses on this order in conjunction with other essential film properties is difficult. The optical loss has several origins, including absorption, mode leakage, internal scattering and surface scattering. When the film surface morphol is accurately known, it is possible to est. the surface scattering component of the loss. The authors have employed at. force microscopy and computer modeling to compute, and correlate the optical loss as a function of film thickness and wavelength. The results suggest upper limits to the morphol. roughness for various device applications. For Li niobate films on sapphire which are intended to frequency double into the blue part of the spectrum, the optimal film thickness is .apprx.400 nm and the root-mean-square roughness is constrained .ltorsim.1.0 nm, with some weak dependence on grain size. Although present growth techniques do not appear to achieve this level of surface flatness intrinsically, an understanding of the morphol development of the film structure may lead to improvements.

CC 73-2 (Optical, Electron, and Mass Spectroscopy and Other Related Properties)

L34 ANSWER 11 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 122:254821 HCA Full-text

TI Microstructural effects in WO3 gas-sensing films

AU Antonik, M. D.; Schneider, J. E.; Wittman, E. L.; Snow, K.; Vetelino, J. F.; Lad, R. J.

CS Laboratory for Surface Science and Technology, 5764 Sawyer Research Center, University of Maine, Orono, ME, 04469-5764, USA

SO Thin Solid Films (1995), 256(1-2), 247-52 CODEN: THSFAP; ISSN: 0040-6090

PB Elsevier

DT Journal

LA English

The microstructure of 50 nm thick WO3 films used in surface acoustic wave (SAW) gas sensors was characterized by at. force microscopy (AFM), XRD and cond. measurements. The films were deposited by r.f. magnetron sputtering onto piezoelec. yz-cut LiNbO3 substrates at 200° and then subjected to annealing treatments in air. As-deposited films are amorphous, have an root-mean-square roughness of 0.6 nm and are easily eroded with the AFM tip. Annealing >315° causes the films to crystallize into a distorted rhenium oxide structure. This crystn. is accompanied by a decrease in film cond. and a surface roughening due to polycryst. grain growth. The cryst. films are more sensitive for H2S gas detection and have faster response characteristics than the amorphous films.

CC 79-2 (Inorganic Analytical Chemistry)

Section cross-reference(s): 76

IT 12031-63-9, Lithium niobate (LiNbO3)

(characterization of tungsten trioxide film on

lithium niobate for surface acoustic wave gas sensor)

L34 ANSWER 12 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 57:75063 HCA Full-text

OREF 57:14867b-d

TI Undamaged germanium surfaces of high optical quality

AU Donovan, T. M.; Seraphin, B. O.

CS Michelson Lab., China Lake, CA

SO Journal of the Electrochemical Society (1962), 109, 877-9

CODEN: JESOAN; ISSN: 0013-4651

DT Journal

LA Unavailable

AB A modification of Sullivan's polishing technique (CA 51, 7902c) gives surfaces of about 0.1 µ/in. flatness and a root mean sq. roughness of only 10-13 A. After mech. polishing, Ge samples are electropolished cathodically on a cloth-covered wheel, contg. KOH in polishing fluid. C. ds. up to 10 ma./sq. in. result in an etching rate of 0.03 µ/min. Electron diffraction shows the surface orientation of the

electropolished samples to be equiv. to those polished in CP-4 soln. Measurements of the surface recombination velocity indicated that the new surface was undamaged to the extent that it ceased to dominate the recombination process in the surface.

the new surface was undamaged to the extent that it

7440-50-8, Copper
(electrodeposition or electroplating of, a.c. and)

RN 7440-50-8 HCA
CN Copper (CA INDEX NAME)

Cu

CC 22 (Electrochemistry)

IT 7440-50-8, Copper

(electrodeposition or electroplating of, a.c. and)

IT 183748-02-9, Electron

(in germanium anodes, soln. and)

L34 ANSWER 13 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 53:33386 HCA Full-text

OREF 53:5923e-f

TI Side conductors for storage batteries

IN Yamaura, Masao; Sekiguchi, Hideto

PA Yuasa Batteries Co.

DT Patent

LA Unavailable

FAN.CNT 1

PATENT NO. KIND DATE APPLICATION NO. DATE

PI JP 32010272

B4 19571210 JP

AB A Cu plate, the surface of which is **roughened** by **means** of sand blasting or etching, is immersed in a molten solder to form a solder layer, and then coated with Pb in a mold to give a side conductor. A strong joint between the Cu and the Pb is obtained.

CC 4 (Electrochemistry)

IT Storage batteries

(conductors for, Pb-coated Cu plate)

IT Electrodes

(storage-battery, Pb-coated Cu plate)

IT 7439-92-1, Lead

(coatings, on Cu for storage-battery conductors)

IT 7440-50-8, Copper

(storage-battery conductors from Pb-coated)

L34 ANSWER 14 OF 14 HCA COPYRIGHT 2007 ACS on STN

AN 43:500 HCA Full-text

OREF 43:94h-i,95a-e

TI Cleaning. Preparation of metals prior to electrodeposition

AU McNair, R.

SO Metal Ind. (London) (1948), 73, 206-208,247-249,252

DT Journal

AB

LA Unavailable

The methods employed for the removal of grease can be divided into 3 sections, org. solvents, alk. chem. and electrochem. cleaners, while scale and other metallic oxides are removed by the use of acids. Other methods include sand or shot-blasting, barreling, grinding, and polishing. Chem. cleaners usually consist of alk. solns. contg. NaOH, sodium metasilicate, KOH, Na2CO3, Na3PO4, and chemicals of like nature, the object being to immerse the articles in a boiling soln. contg. a mixt. of the above-mentioned chemicals which emulsifies or saponifies the grease so that it becomes sol. in H2O. A method of degreasing that finds much favor for the removal of very heavy grease and oil is the org.-solvent degreaser. Al and Zn should never be made the anode in an alk. cleaner as corrosion will occur that is not easily removed; nor is it advisable to allow Zn articles to be cathodic for more than a min. as the absorption of H2 may be the cause of blistering of the deposit after the article has been in service a short time. Steel is another metal that should not be allowed to remain the cathode for too long a period as this may cause H2 embrittlement. Certain chemicals have the power to reduce the surface tension of liquids, and this has been utilized in metal cleaning to assist the penetration of the cleaner. This action is also known as wetting, and the

chemicals employed are usually sulfonated compds. HCl and H2SO4 are generally used for pickling Fe and steel, HNO3 or a mixt. of HNO3 and H2SO4 for brass and Cu, while sand and rust can be removed from sand castings by immersion in a mixt. of HF and H2SO4. The cleaning of brass can be divided into two categories: (a) Where the aim is to obtain a purely decorative finish; this particular bright-dip brass finish is also employed for certain types of plated work when a satin finish is required. (b) Where the cleaning and dipping process is employed as a means of removing grease and scale prior to polishing, plating, or soldering. If a brass finish is desired the usual practice is to lacquer the articles with a clear colorless lacquer to preserve the color. Numerous methods are available for pickling ferrous metals. Of the acids employed, HCl and H2SO4 are the most common, although HF and HNO3 also have their uses. The Bullard Dun Process consists in making the articles to be treated the cathode in a hot dil. soln. of H2SO4 plus the addn. of a min. quantity of SnSO4. Scale on stainless steel resulting from heat-treatment is very resistant to acids and com. pickling is usually carried out at elevated temps. The pickling and etching of Al is adopted as a means of roughening the surface to form a key ground for subsequent painting and etching as a means of obtaining a satin decorative finish on a com. basis.

T 7440-50-8, Copper (cleaning compns. for, before electroplating)
 RN 7440-50-8 HCA
 CN Copper (CA INDEX NAME)

Cu

CC 9 (Metallurgy and Metallography)IT 7440-50-8, Copper (cleaning compns. for, before electroplating)